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**Kim et al.**

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(54) **HOUSING FOR PACKAGING SEMICONDUCTOR LIGHT EMITTING DEVICE**

(71) Applicant: **SEMICON LIGHT CO., LTD.**,  
Gyeonggi-do (KR)  
(72) Inventors: **Kyoung Min Kim**, Gyeonggi-do (KR);  
**Gye Oul Jeong**, Gyeonggi-do (KR)  
(73) Assignee: **SEMICON LIGHT CO., LTD.**,  
Gyeonggi-Do (KR)

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(52) **U.S. Cl.**  
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(58) **Field of Classification Search**

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D9/434, 455-457, 759; D3/304, 295;  
D7/550.1, 553.1-553.8, 581, 586, 587;  
D24/227, 229, 230; 428/131; 229/120;  
220/4.21; 206/733, 528, 486, 485, 427,  
206/461, 828

CPC ..... H01J 5/48; H01J 5/50; H01J 19/54; A61B  
10/0096; A61B 50/20; A61B 50/30; A61C  
2202/00; A61J 1/16; A63B 57/203; B25H  
3/003; B44D 3/125; B65D 73/0092;  
B65D 81/025

See application file for complete search history.

(56) **References Cited**

**U.S. PATENT DOCUMENTS**

6,065,596 A \* 5/2000 Cavanagh ..... A61B 50/20  
206/352

D502,348 S \* 3/2005 Mendini ..... D6/553  
D502,833 S \* 3/2005 Mendini ..... D6/553  
D605,610 S \* 12/2009 Han ..... D13/180  
D645,425 S \* 9/2011 Lin ..... D13/180  
D647,070 S \* 10/2011 Huang ..... D13/180  
D647,864 S \* 11/2011 Huang ..... D13/180  
D648,286 S \* 11/2011 Chuang ..... D13/180  
D648,630 S \* 11/2011 Doster ..... D19/83  
D652,808 S \* 1/2012 Chang ..... D13/180  
D656,106 S \* 3/2012 Hsu ..... D13/180  
8,415,692 B2 4/2013 Toquin ..... 257/98  
8,610,140 B2 12/2013 Joo et al. .... 257/88  
8,748,915 B2 6/2014 Chan et al. .... 257/91  
D790,964 S \* 7/2017 Akana ..... D9/424  
D793,001 S \* 7/2017 Kim ..... D26/120  
D793,618 S \* 8/2017 Kim ..... D26/120

(Continued)

*Primary Examiner* — Cathron C Brooks

*Assistant Examiner* — W. A. Teddy Falloway

(74) *Attorney, Agent, or Firm* — Harness, Dickey &  
Pierce, P.L.C.

(57) **CLAIM**

The ornamental design for a housing for packaging semi-conductor light emitting device, as shown and described.

**DESCRIPTION**

FIG. 1 is a perspective view of a housing for packaging semiconductor light emitting device, showing our new design;

FIG. 2 is a front view thereof;

FIG. 3 is a rear view thereof;

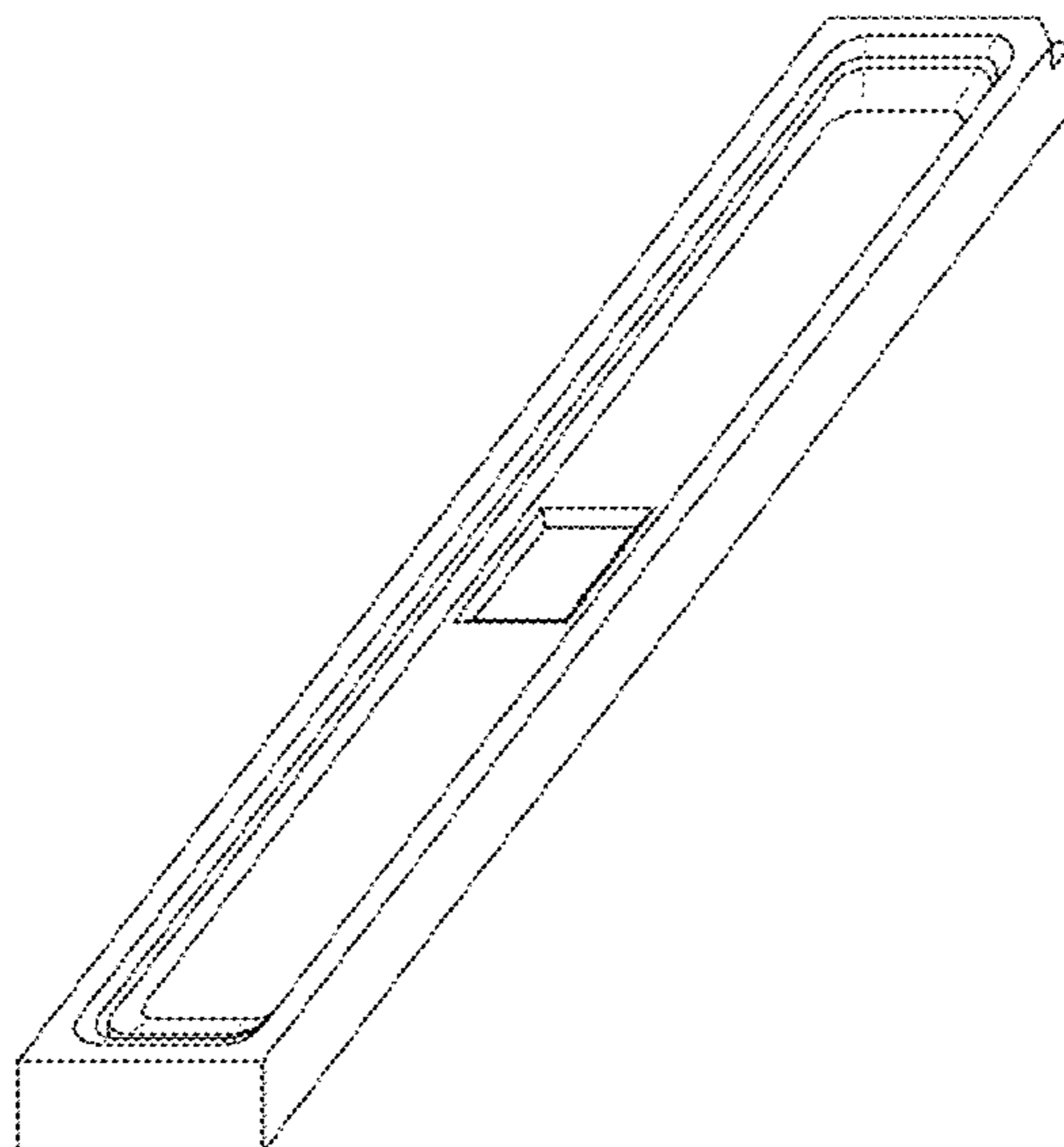
FIG. 4 is a left side view thereof;

FIG. 5 is a right side view thereof;

FIG. 6 is a top view thereof; and,

FIG. 7 is a bottom view thereof.

**1 Claim, 6 Drawing Sheets**



(56)

**References Cited**

U.S. PATENT DOCUMENTS

D795,492 S \* 8/2017 Kim ..... D26/120  
D800,337 S \* 10/2017 Daines ..... D24/227  
2016/0064993 A1\* 3/2016 Fetterman ..... H02J 7/0044  
320/137

\* cited by examiner

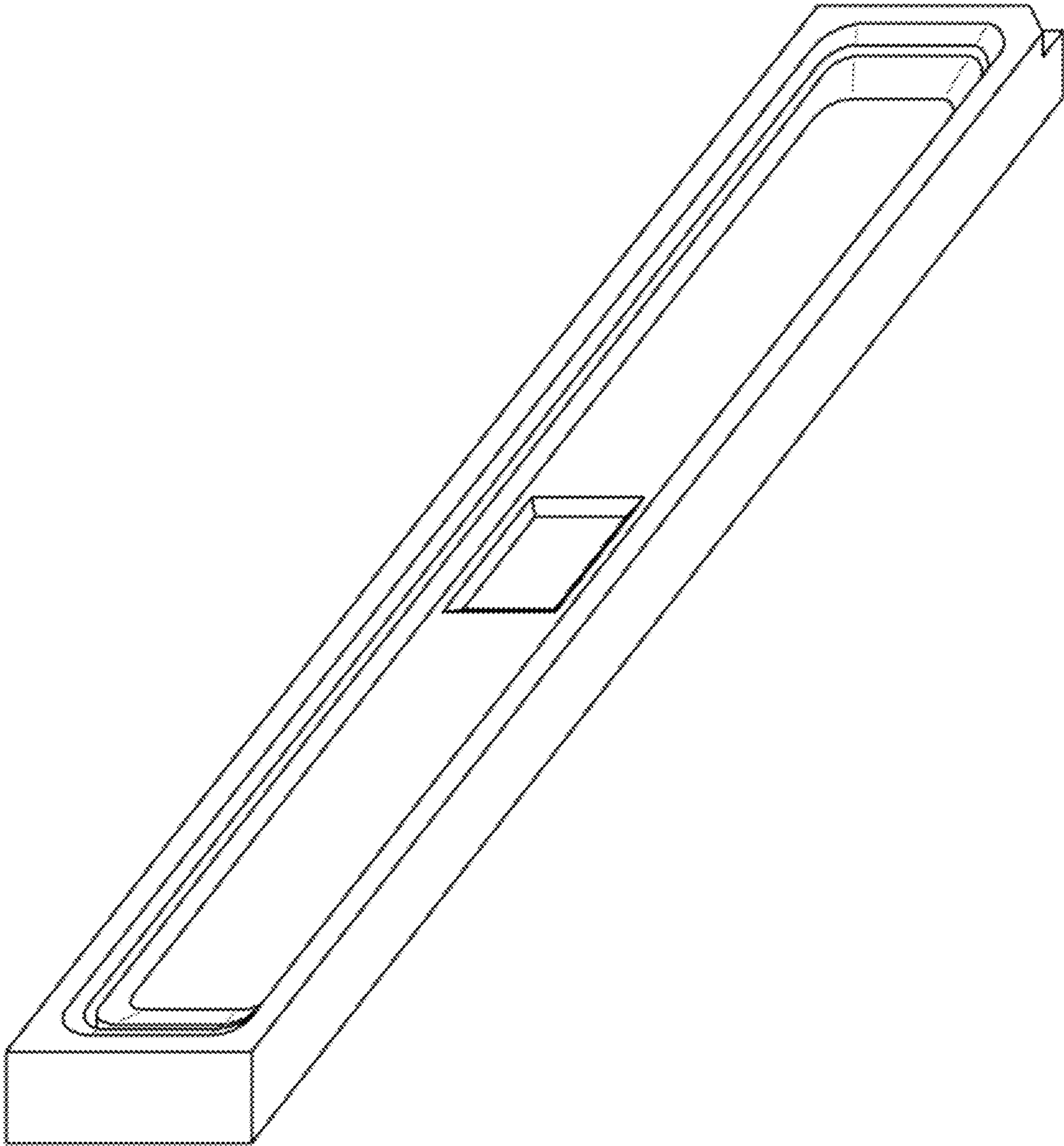
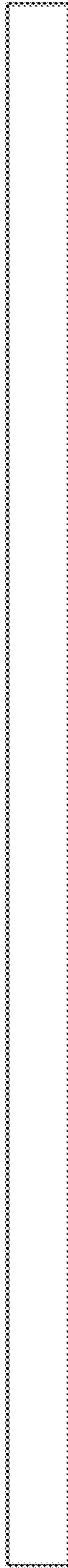


FIG. 1



FIG. 2



**FIG. 3**



**FIG. 4**



**FIG. 5**

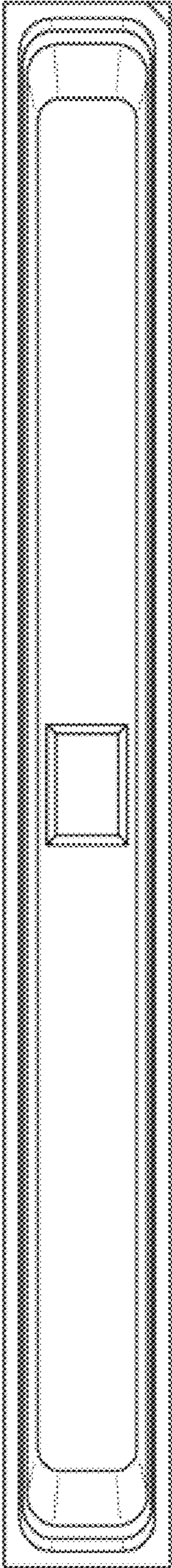


FIG. 6

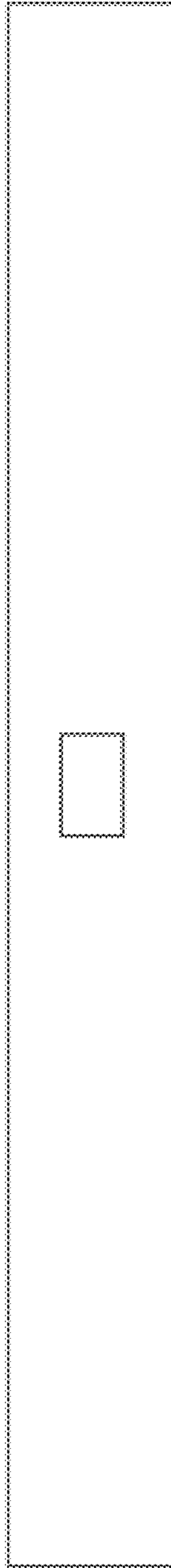


FIG. 7